PCN: PCN_KVR16R11S4_8I_C5 Date: September 14, 2015 Kingston Technology Company 17600 Newhope Street Fountain Valley, CA 92708 USA

KINOS

Type of Change:	Build (BOM) Phase Out for End of Life
Product Affected:	KVR16R11S4/8I
	KVR16R11S4K3/24I Kit of 3
	KVR16R11S4K4/32I Kit of 4
Qualified Build:	9965433-154.A00LF (Kingston F Die) – PHASE OUT FOR EOL
Qualified Build:	9965433-403.A00LF (Hynix B Die) – SHIPPING
Product Description:	8GB DDR3-1600 Registered DIMM CL11 1Rx4 1.5V Intel Certified 8GB PC3-12800R-11-12-C2 1Rx4
Change Description:	Build 9965433-154.A00LF using Kingston F Die (D1024ED1FPGGB) is being phased out for end of life due to lack of DRAM components. Alternate Intel qualified build 9965433- 403.A00LF using Hynix B Die available and shipping.
Phase Out Notice:	September 14, 2015
Target End of Life:	December 14, 2015
Change Description:	8GB PC3-12800R-11-12-C2 1Rx4 Build 9965433-154.A00LF using Kingston F Die (D1024ED1FPGGB) is being phased of end of life due to lack of DRAM components. Alternate Intel qualified build 9965433- 403.A00LF using Hynix B Die available and shipping. September 14, 2015

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Please contact your Kingston Sales Representative for further information.
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